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Details

Product Status	Obsolete
Core Processor	HC08
Core Size	8-Bit
Speed	8MHz
Connectivity	-
Peripherals	LVD, POR, PWM
Number of I/O	13
Program Memory Size	1.5KB (1.5K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	128 x 8
Voltage - Supply (Vcc/Vdd)	2.7V ~ 5.5V
Data Converters	-
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Through Hole
Package / Case	16-DIP (0.300", 7.62mm)
Supplier Device Package	16-PDIP
Purchase URL	https://www.e-xfl.com/product-detail/nxp-semiconductors/mc68hc908qy1cpe

Revision History (Sheet 2 of 3)

Date	Revision Level	Description	Page Number(s)
August, 2003	1.0	Reformatted to meet latest M68HC08 documentation standards	N/A
		Figure 1-1. Block Diagram — Diagram redrawn to include keyboard interrupt module and TCLK pin designator.	20
		Figure 1-2. MCU Pin Assignments — Added TCLK pin designator.	21
		Table 1-2. Pin Functions — Added TCLK pin description.	22
		Table 1-3. Function Priority in Shared Pins — Revised table for clarity and to add TCLK.	23
		Figure 2-1. Memory Map — Corrected names for the IRQ status and control register (INTSCR) bits 3–0.	26
		3.7.3 ADC Input Clock Register — Clarified bit description for the ADC clock prescaler bits.	47
		4.3 Functional Description — Updated periodic wakeup request values.	51
		Figure 6-1. COP Block Diagram — Reworked for clarity	59
		Chapter 8 External Interrupt (IRQ) — Corrected bit names for MODE, IRQF, ACK, and IMASK	77–79
		Chapter 14 Timer Interface Module (TIM) — Added TCLK function.	131–139
		15.3 Monitor Module (MON) — Updated with additional data.	147
		Chapter 16 Electrical Specifications — Updated with additional data.	169–173
October, 2003	2.0	Figure 2-2. Control, Status, and Data Registers — Deleted unimplemented areas from \$FFB0–\$FFBD and \$FFC2–\$FFCF as they are actually available. Also corrected \$FFBF designation from unimplemented to reserved.	27
		Figure 6-1. COP Block Diagram — Reworked for clarity	59
		6.3.2 STOP Instruction — Added subsection	60
		13.4.2 Active Resets from Internal Sources — Reworked notes for clarity.	111
		Table 13-2. Reset Recovery Timing — Replaced previous table with new information.	112
		Chapter 14 Timer Interface Module (TIM) — Updated with additional data.	131
		Figure 15-3. Break I/O Register Summary — Corrected bit designators for the BRKAR register	143
		15.3 Monitor Module (MON) — Clarified seventh bullet.	147
		Table 17-1. MC Order Numbers — Corrected temperature and package designators.	175
January, 2004	3.0	Figure 2-2. Control, Status, and Data Registers — Corrected reset state for the FLASH Block Protect Register at address location \$FFBE and the Internal Oscillator Trim Value at \$FFC0.	32
		Figure 2-5. FLASH Block Protect Register (FLBPR) — Restated reset state for clarity.	38

1.5 Pin Functions

Table 1-2 provides a description of the pin functions.

Table 1-2. Pin Functions

Pin Name	Description	Input/Output
V _{DD}	Power supply	Power
V _{SS}	Power supply ground	Power
PTA0	PTA0 — General purpose I/O port	Input/Output
	AD0 — A/D channel 0 input	Input
	TCH0 — Timer Channel 0 I/O	Input/Output
	KBI0 — Keyboard interrupt input 0	Input
PTA1	PTA1 — General purpose I/O port	Input/Output
	AD1 — A/D channel 1 input	Input
	TCH1 — Timer Channel 1 I/O	Input/Output
	KBI1 — Keyboard interrupt input 1	Input
PTA2	PTA2 — General purpose input-only port	Input
	\overline{IRQ} — External interrupt with programmable pullup and Schmitt trigger input	Input
	KBI2 — Keyboard interrupt input 2	Input
	TCLK — Timer clock input	Input
PTA3	PTA3 — General purpose I/O port	Input/Output
	\overline{RST} — Reset input, active low with internal pullup and Schmitt trigger	Input
	KBI3 — Keyboard interrupt input 3	Input
PTA4	PTA4 — General purpose I/O port	Input/Output
	OSC2 — XTAL oscillator output (XTAL option only) RC or internal oscillator output (OSC2EN = 1 in PTAPUE register)	Output Output
	AD2 — A/D channel 2 input	Input
	KBI4 — Keyboard interrupt input 4	Input
PTA5	PTA5 — General purpose I/O port	Input/Output
	OSC1 — XTAL, RC, or external oscillator input	Input
	AD3 — A/D channel 3 input	Input
	KBI5 — Keyboard interrupt input 5	Input
PTB[0:7] ⁽¹⁾	8 general-purpose I/O ports	Input/Output

1. The PTB pins are not available on the 8-pin packages (see note in [12.1 Introduction](#)).

Memory

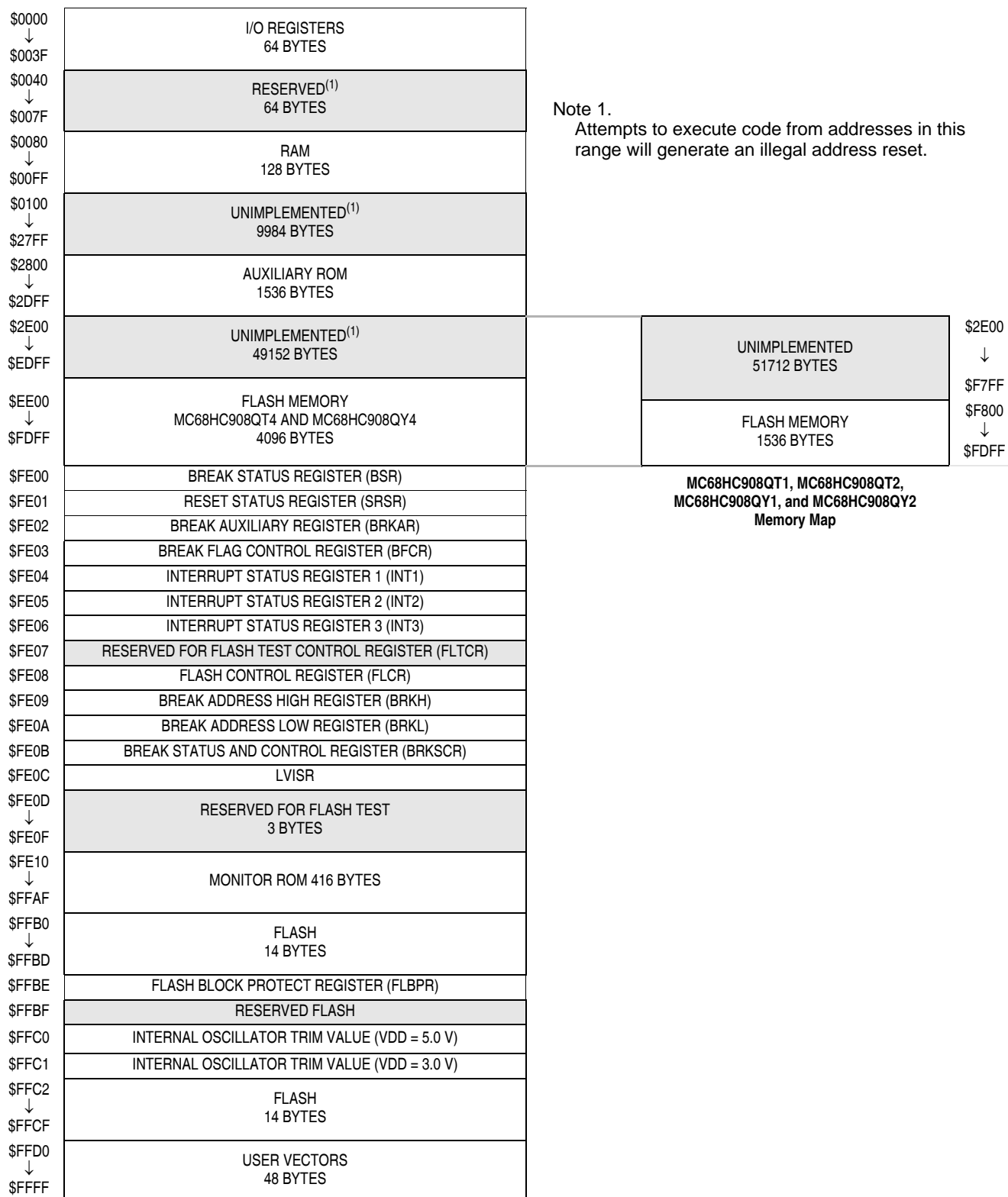
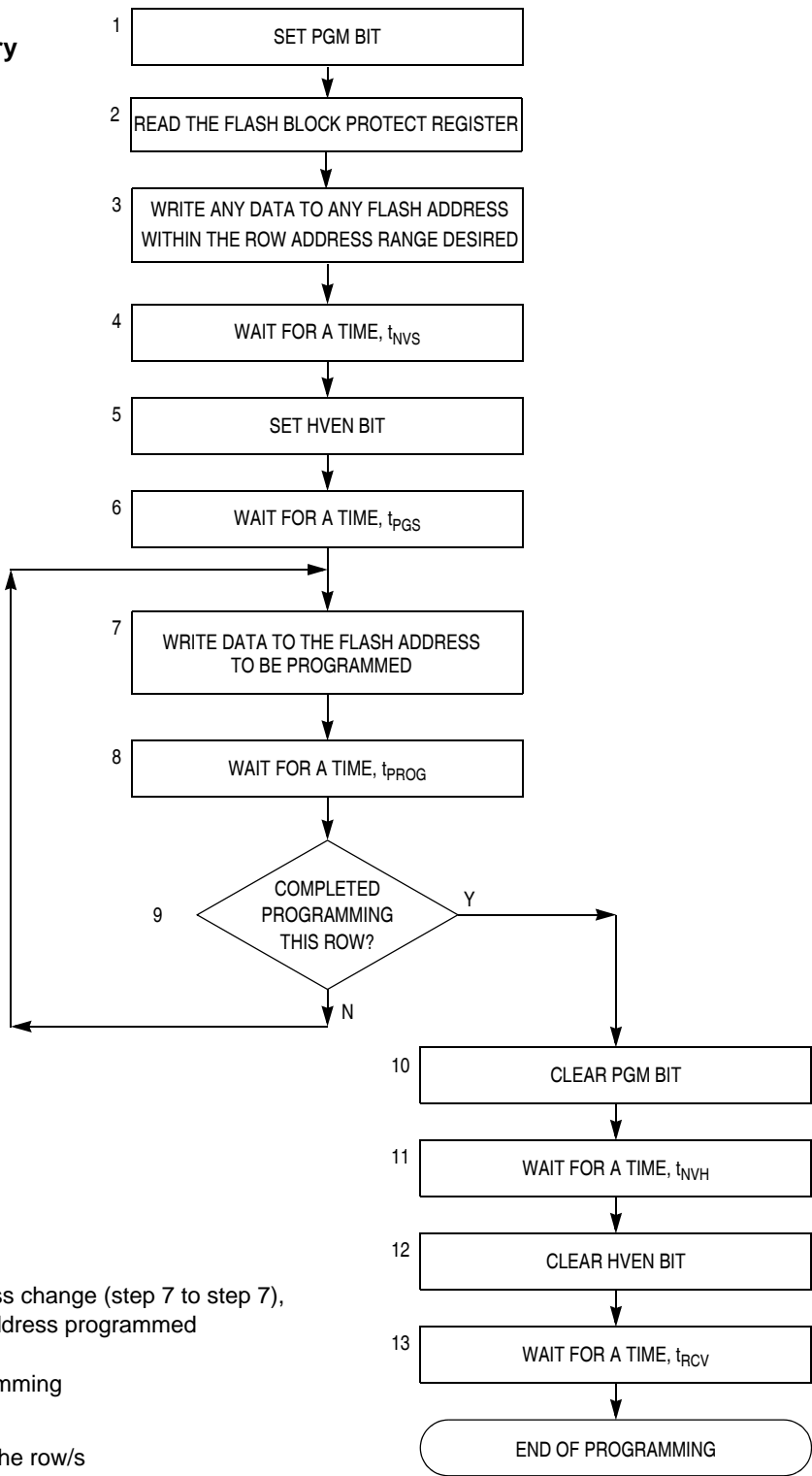


Figure 2-1. Memory Map

**Algorithm for Programming
a Row (32 Bytes) of FLASH Memory**



NOTES:

The time between each FLASH address change (step 7 to step 7), or the time between the last FLASH address programmed to clearing PGM bit (step 7 to step 10) must not exceed the maximum programming time, $t_{\text{PROG max}}$.

This row program algorithm assumes the row/s to be programmed are initially erased.

Figure 2-4. FLASH Programming Flowchart

Chapter 3

Analog-to-Digital Converter (ADC)

3.1 Introduction

This section describes the analog-to-digital converter (ADC). The ADC is an 8-bit, 4-channel analog-to-digital converter. The ADC module is only available on the MC68HC908QY2, MC68HC908QT2, MC68HC908QY4, and MC68HC908QT4.

3.2 Features

Features of the ADC module include:

- 4 channels with multiplexed input
- Linear successive approximation with monotonicity
- 8-bit resolution
- Single or continuous conversion
- Conversion complete flag or conversion complete interrupt
- Selectable ADC clock frequency

3.3 Functional Description

Four ADC channels are available for sampling external sources at pins PTA0, PTA1, PTA4, and PTA5. An analog multiplexer allows the single ADC converter to select one of the four ADC channels as an ADC voltage input (ADCVIN). ADCVIN is converted by the successive approximation register-based counters. The ADC resolution is eight bits. When the conversion is completed, ADC puts the result in the ADC data register and sets a flag or generates an interrupt.

Figure 3-2 shows a block diagram of the ADC.

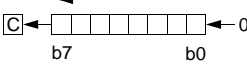
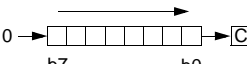
3.3.1 ADC Port I/O Pins

PTA0, PTA1, PTA4, and PTA5 are general-purpose I/O pins that are shared with the ADC channels. The channel select bits (ADC status and control register (ADSCR), \$003C), define which ADC channel/port pin will be used as the input signal. The ADC overrides the port I/O logic by forcing that pin as input to the ADC. The remaining ADC channels/port pins are controlled by the port I/O logic and can be used as general-purpose I/O. Writes to the port register or data direction register (DDR) will not have any effect on the port pin that is selected by the ADC. Read of a port pin which is in use by the ADC will return a 0 if the corresponding DDR bit is at 0. If the DDR bit is at 1, the value in the port data latch is read.

Table 7-1. Instruction Set Summary (Sheet 3 of 6)

Source Form	Operation	Description	Effect on CCR						Address Mode	Opcode	Operand	Cycles
			V	H	I	N	Z	C				
CLI	Clear Interrupt Mask	$I \leftarrow 0$	–	–	0	–	–	–	INH	9A		2
CLR <i>opr</i> CLRA CLR <i>X</i> CLR <i>H</i> CLR <i>opr,X</i> CLR <i>,X</i> CLR <i>opr,SP</i>	Clear	$M \leftarrow \$00$ $A \leftarrow \$00$ $X \leftarrow \$00$ $H \leftarrow \$00$ $M \leftarrow \$00$ $M \leftarrow \$00$ $M \leftarrow \$00$	0	–	–	0	1	–	DIR INH INH INH IX1 IX SP1	3F 4F 5F 8C 6F 7F 9E6F	dd ff ff	3 1 1 1 3 2 4
CMP # <i>opr</i> CMP <i>opr</i> CMP <i>opr</i> CMP <i>opr,X</i> CMP <i>opr,X</i> CMP <i>,X</i> CMP <i>opr,SP</i> CMP <i>opr,SP</i>	Compare A with M	$(A) - (M)$	†	–	–	†	†	†	IMM DIR EXT IX2 IX1 IX SP1 SP2	A1 B1 C1 D1 E1 F1 9EE1 9ED1	ii dd hh ll ee ff ff ff ff ee ff	2 3 4 4 3 2 4 5
COM <i>opr</i> COMA COM <i>X</i> COM <i>opr,X</i> COM <i>,X</i> COM <i>opr,SP</i>	Complement (One's Complement)	$M \leftarrow (\overline{M}) = \$FF - (M)$ $A \leftarrow (\overline{A}) = \$FF - (M)$ $X \leftarrow (\overline{X}) = \$FF - (M)$ $M \leftarrow (\overline{M}) = \$FF - (M)$ $M \leftarrow (\overline{M}) = \$FF - (M)$ $M \leftarrow (\overline{M}) = \$FF - (M)$	0	–	–	†	†	1	DIR INH INH IX1 IX SP1	33 43 53 63 73 9E63	dd ff ff	4 1 1 4 3 5
CPHX # <i>opr</i> CPHX <i>opr</i>	Compare H:X with M	$(H:X) - (M:M + 1)$	†	–	–	†	†	†	IMM DIR	65 75	ii ii+1 dd	3 4
CPX # <i>opr</i> CPX <i>opr</i> CPX <i>opr</i> CPX <i>,X</i> CPX <i>opr,X</i> CPX <i>opr,X</i> CPX <i>opr,SP</i> CPX <i>opr,SP</i>	Compare X with M	$(X) - (M)$	†	–	–	†	†	†	IMM DIR EXT IX2 IX1 IX SP1 SP2	A3 B3 C3 D3 E3 F3 9EE3 9ED3	ii dd hh ll ee ff ff ff ff ee ff	2 3 4 4 3 2 4 5
DAA	Decimal Adjust A	$(A)_{10}$	U	–	–	†	†	†	INH	72		2
DBNZ <i>opr,rel</i> DBNZ <i>A,rel</i> DBNZ <i>X,rel</i> DBNZ <i>opr,X,rel</i> DBNZ <i>X,rel</i> DBNZ <i>opr,SP,rel</i>	Decrement and Branch if Not Zero	$A \leftarrow (A) - 1$ or $M \leftarrow (M) - 1$ or $X \leftarrow (X) - 1$ $PC \leftarrow (PC) + 3 + rel ? (result) \neq 0$ $PC \leftarrow (PC) + 2 + rel ? (result) \neq 0$ $PC \leftarrow (PC) + 2 + rel ? (result) \neq 0$ $PC \leftarrow (PC) + 3 + rel ? (result) \neq 0$ $PC \leftarrow (PC) + 2 + rel ? (result) \neq 0$ $PC \leftarrow (PC) + 4 + rel ? (result) \neq 0$	–	–	–	–	–	–	DIR INH INH IX1 IX SP1	3B 4B 5B 6B 7B 9E6B	dd rr rr rr ff rr rr ff rr	5 3 3 5 4 6
DEC <i>opr</i> DECA DEC <i>X</i> DEC <i>opr,X</i> DEC <i>,X</i> DEC <i>opr,SP</i>	Decrement	$M \leftarrow (M) - 1$ $A \leftarrow (A) - 1$ $X \leftarrow (X) - 1$ $M \leftarrow (M) - 1$ $M \leftarrow (M) - 1$ $M \leftarrow (M) - 1$	†	–	–	†	†	–	DIR INH INH IX1 IX SP1	3A 4A 5A 6A 7A 9E6A	dd ff ff	4 1 1 4 3 5
DIV	Divide	$A \leftarrow (H:A)/(X)$ $H \leftarrow \text{Remainder}$	–	–	–	–	†	†	INH	52		7
EOR # <i>opr</i> EOR <i>opr</i> EOR <i>opr</i> EOR <i>opr,X</i> EOR <i>opr,X</i> EOR <i>,X</i> EOR <i>opr,SP</i> EOR <i>opr,SP</i>	Exclusive OR M with A	$A \leftarrow (A \oplus M)$	0	–	–	†	†	–	IMM DIR EXT IX2 IX1 IX SP1 SP2	A8 B8 C8 D8 E8 F8 9EE8 9ED8	ii dd hh ll ee ff ff ff ff ee ff	2 3 4 4 3 2 4 5
INC <i>opr</i> INCA INC <i>X</i> INC <i>opr,X</i> INC <i>,X</i> INC <i>opr,SP</i>	Increment	$M \leftarrow (M) + 1$ $A \leftarrow (A) + 1$ $X \leftarrow (X) + 1$ $M \leftarrow (M) + 1$ $M \leftarrow (M) + 1$ $M \leftarrow (M) + 1$	†	–	–	†	†	–	DIR INH INH IX1 IX SP1	3C 4C 5C 6C 7C 9E6C	dd ff ff	4 1 1 4 3 5

Table 7-1. Instruction Set Summary (Sheet 4 of 6)

Source Form	Operation	Description	Effect on CCR						Address Mode	Opcode	Operand	Cycles
			V	H	I	N	Z	C				
JMP <i>opr</i> JMP <i>opr</i> JMP <i>opr</i> ,X JMP <i>opr</i> ,X JMP ,X	Jump	PC ← Jump Address	–	–	–	–	–	–	DIR EXT IX2 IX1 IX	BC CC DC EC FC	dd hh ll ee ff ff	2 3 4 3 2
JSR <i>opr</i> JSR <i>opr</i> JSR <i>opr</i> ,X JSR <i>opr</i> ,X JSR ,X	Jump to Subroutine	PC ← (PC) + <i>n</i> (<i>n</i> = 1, 2, or 3) Push (PCL); SP ← (SP) – 1 Push (PCH); SP ← (SP) – 1 PC ← Unconditional Address	–	–	–	–	–	–	DIR EXT IX2 IX1 IX	BD CD DD ED FD	dd hh ll ee ff ff	4 5 6 5 4
LDA # <i>opr</i> LDA <i>opr</i> LDA <i>opr</i> LDA <i>opr</i> ,X LDA <i>opr</i> ,X LDA ,X LDA <i>opr</i> ,SP LDA <i>opr</i> ,SP	Load A from M	A ← (M)	0	–	–	↑	↑	–	IMM DIR EXT IX2 IX1 IX SP1 SP2	A6 B6 C6 D6 E6 F6 9EE6 9ED6	ii dd hh ll ee ff ff ff ee ff	2 3 4 4 3 2 4 5
LDHX # <i>opr</i> LDHX <i>opr</i>	Load H:X from M	H:X ← (M:M + 1)	0	–	–	↑	↑	–	IMM DIR	45 55	ii jj dd	3 4
LDX # <i>opr</i> LDX <i>opr</i> LDX <i>opr</i> LDX <i>opr</i> ,X LDX <i>opr</i> ,X LDX ,X LDX <i>opr</i> ,SP LDX <i>opr</i> ,SP	Load X from M	X ← (M)	0	–	–	↑	↑	–	IMM DIR EXT IX2 IX1 IX SP1 SP2	AE BE CE DE EE FE 9EEE 9EDE	ii dd hh ll ee ff ff ff ff ee ff	2 3 4 4 3 2 4 5
LSL <i>opr</i> LSLA LSLX LSL <i>opr</i> ,X LSL ,X LSL <i>opr</i> ,SP	Logical Shift Left (Same as ASL)		↑	–	–	↑	↑	↑	DIR INH INH IX1 IX SP1	38 48 58 68 78 9E68	dd ff ff	4 1 1 4 3 5
LSR <i>opr</i> LSRA LSRX LSR <i>opr</i> ,X LSR ,X LSR <i>opr</i> ,SP	Logical Shift Right		↑	–	–	0	↑	↑	DIR INH INH IX1 IX SP1	34 44 54 64 74 9E64	dd ff ff	4 1 1 4 3 5
MOV <i>opr</i> , <i>opr</i> MOV <i>opr</i> ,X+ MOV # <i>opr</i> , <i>opr</i> MOV X+, <i>opr</i>	Move	(M) _{Destination} ← (M) _{Source} H:X ← (H:X) + 1 (IX+D, DIX+)	0	–	–	↑	↑	–	DD DIX+ IMD IX+D	4E 5E 6E 7E	dd dd dd ii dd dd	5 4 4 4
MUL	Unsigned multiply	X:A ← (X) × (A)	–	0	–	–	–	0	INH	42		5
NEG <i>opr</i> NEGA NEGX NEG <i>opr</i> ,X NEG ,X NEG <i>opr</i> ,SP	Negate (Two's Complement)	M ← –(M) = \$00 – (M) A ← –(A) = \$00 – (A) X ← –(X) = \$00 – (X) M ← –(M) = \$00 – (M) M ← –(M) = \$00 – (M)	↑	–	–	↑	↑	↑	DIR INH INH IX1 IX SP1	30 40 50 60 70 9E60	dd ff ff ff	4 1 1 4 3 5
NOP	No Operation	None	–	–	–	–	–	–	INH	9D		1
NSA	Nibble Swap A	A ← (A[3:0]:A[7:4])	–	–	–	–	–	–	INH	62		3
ORA # <i>opr</i> ORA <i>opr</i> ORA <i>opr</i> ORA <i>opr</i> ,X ORA <i>opr</i> ,X ORA ,X ORA <i>opr</i> ,SP ORA <i>opr</i> ,SP	Inclusive OR A and M	A ← (A) (M)	0	–	–	↑	↑	–	IMM DIR EXT IX2 IX1 IX SP1 SP2	AA BA CA DA EA FA 9EEA 9EDA	ii dd hh ll ee ff ff ff ff ee ff	2 3 4 4 3 2 4 5
PSHA	Push A onto Stack	Push (A); SP ← (SP) – 1	–	–	–	–	–	–	INH	87		2
PSHH	Push H onto Stack	Push (H); SP ← (SP) – 1	–	–	–	–	–	–	INH	8B		2
PSHX	Push X onto Stack	Push (X); SP ← (SP) – 1	–	–	–	–	–	–	INH	89		2

Chapter 9

Keyboard Interrupt Module (KBI)

9.1 Introduction

The keyboard interrupt module (KBI) provides six independently maskable external interrupts, which are accessible via the PTA0–PTA5 pins.

9.2 Features

Features of the keyboard interrupt module include:

- Six keyboard interrupt pins with separate keyboard interrupt enable bits and one keyboard interrupt mask
- Software configurable pullup device if input pin is configured as input port bit
- Programmable edge-only or edge and level interrupt sensitivity
- Exit from low-power modes

9.3 Functional Description

The keyboard interrupt module controls the enabling/disabling of interrupt functions on the six port A pins. These six pins can be enabled/disabled independently of each other. Refer to [Figure 9-2](#).

9.3.1 Keyboard Operation

Writing to the KBIE0–KBIE5 bits in the keyboard interrupt enable register (KBIER) independently enables or disables each port A pin as a keyboard interrupt pin. Enabling a keyboard interrupt pin in port A also enables its internal pullup device irrespective of PTAPUEx bits in the port A input pullup enable register (see [12.2.3 Port A Input Pullup Enable Register](#)). A logic 0 applied to an enabled keyboard interrupt pin latches a keyboard interrupt request.

A keyboard interrupt is latched when one or more keyboard interrupt inputs goes low after all were high. The MODEK bit in the keyboard status and control register controls the triggering mode of the keyboard interrupt.

- If the keyboard interrupt is edge-sensitive only, a falling edge on a keyboard interrupt input does not latch an interrupt request if another keyboard pin is already low. To prevent losing an interrupt request on one input because another input is still low, software can disable the latter input while it is low.
- If the keyboard interrupt is falling edge and low-level sensitive, an interrupt request is present as long as any keyboard interrupt input is low.

11.4.2 Crystal Amplifier Output Pin (OSC2/PTA4/BUSCLKX4)

For the XTAL oscillator device, the OSC2 pin is the crystal oscillator inverting amplifier output.

For the external clock option, the OSC2 pin is dedicated to the PTA4 I/O function. The OSC2EN bit has no effect.

For the internal oscillator or RC oscillator options, the OSC2 pin can assume other functions according to [Table 1-3. Function Priority in Shared Pins](#), or the output of the oscillator clock (BUSCLKX4).

Table 11-1. OSC2 Pin Function

Option	OSC2 Pin Function
XTAL oscillator	Inverting OSC1
External clock	PTA4 I/O
Internal oscillator or RC oscillator	Controlled by OSC2EN bit in PTAPUE register OSC2EN = 0: PTA4 I/O OSC2EN = 1: BUSCLKX4 output

11.4.3 Oscillator Enable Signal (SIMOSCEN)

The SIMOSCEN signal comes from the system integration module (SIM) and enables/disables either the XTAL oscillator circuit, the RC oscillator, or the internal oscillator.

11.4.4 XTAL Oscillator Clock (XTALCLK)

XTALCLK is the XTAL oscillator output signal. It runs at the full speed of the crystal (f_{XCLK}) and comes directly from the crystal oscillator circuit. [Figure 11-2](#) shows only the logical relation of XTALCLK to OSC1 and OSC2 and may not represent the actual circuitry. The duty cycle of XTALCLK is unknown and may depend on the crystal and other external factors. Also, the frequency and amplitude of XTALCLK can be unstable at start up.

11.4.5 RC Oscillator Clock (RCCLK)

RCCLK is the RC oscillator output signal. Its frequency is directly proportional to the time constant of external R and internal C. [Figure 11-3](#) shows only the logical relation of RCCLK to OSC1 and may not represent the actual circuitry.

11.4.6 Internal Oscillator Clock (INTCLK)

INTCLK is the internal oscillator output signal. Its nominal frequency is fixed to 12.8 MHz, but it can be also trimmed using the oscillator trimming feature of the OSCTRIM register (see [11.3.1.1 Internal Oscillator Trimming](#)).

11.4.7 Oscillator Out 2 (BUSCLKX4)

BUSCLKX4 is the same as the input clock (XTALCLK, RCCLK, or INTCLK). This signal is driven to the SIM module and is used to determine the COP cycles.

11.4.8 Oscillator Out (BUSCLKX2)

The frequency of this signal is equal to half of the BUSCLKX4, this signal is driven to the SIM for generation of the bus clocks used by the CPU and other modules on the MCU. BUSCLKX2 will be divided

A module that is active during wait mode can wake up the CPU with an interrupt if the interrupt is enabled. Stacking for the interrupt begins one cycle after the WAIT instruction during which the interrupt occurred. In wait mode, the CPU clocks are inactive. Refer to the wait mode subsection of each module to see if the module is active or inactive in wait mode. Some modules can be programmed to be active in wait mode.

Wait mode can also be exited by a reset (or break in emulation mode). A break interrupt during wait mode sets the SIM break stop/wait bit, SBSW, in the break status register (BSR). If the COP disable bit, COPD, in the configuration register is 0, then the computer operating properly module (COP) is enabled and remains active in wait mode.

Figure 13-15 and Figure 13-16 show the timing for wait recovery.

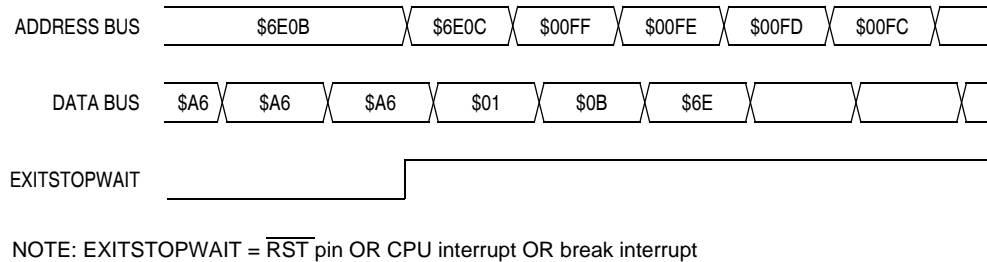


Figure 13-15. Wait Recovery from Interrupt

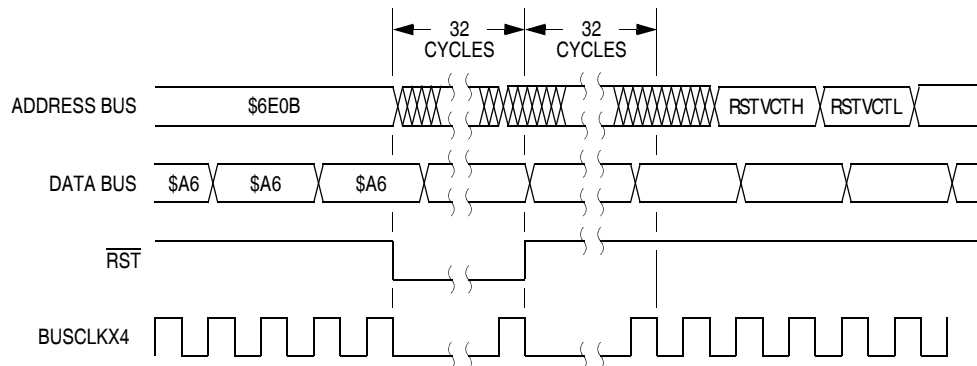


Figure 13-16. Wait Recovery from Internal Reset

13.7.2 Stop Mode

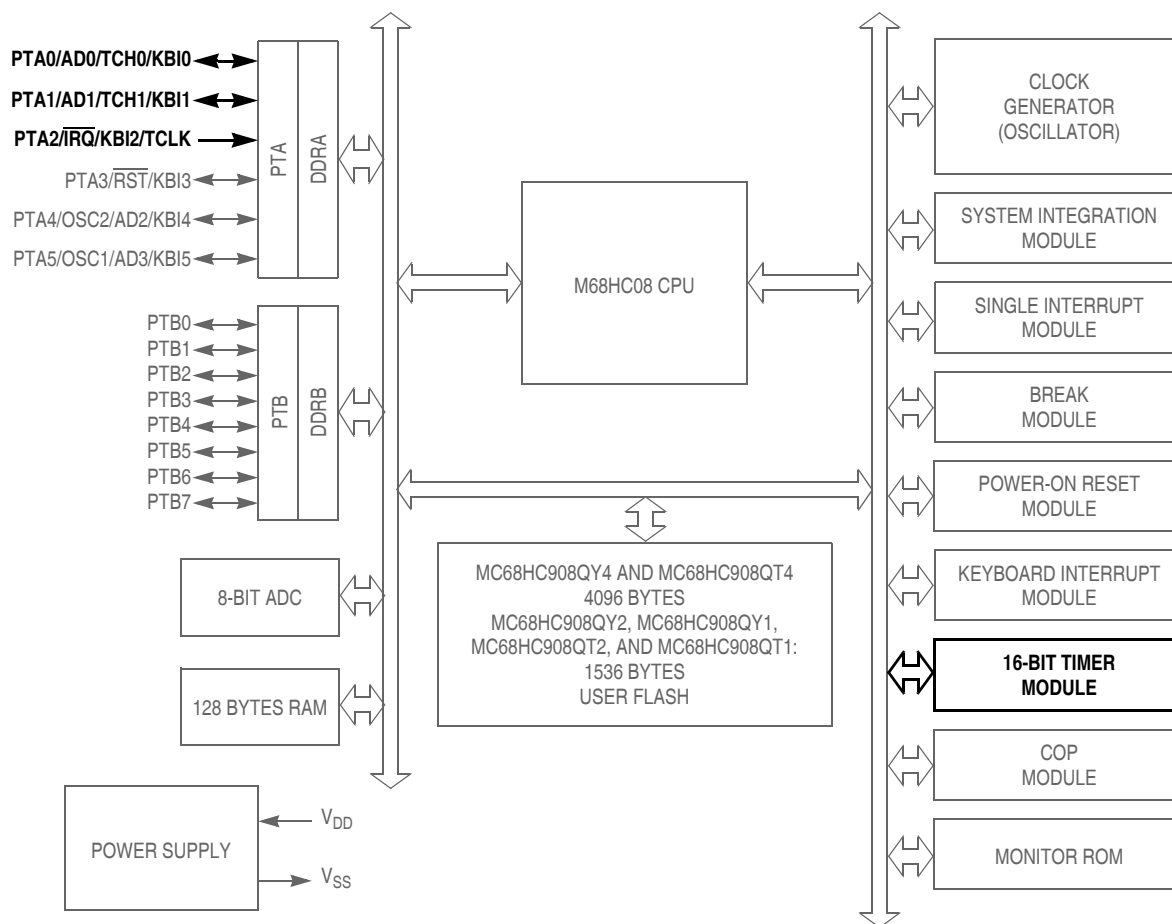
In stop mode, the SIM counter is reset and the system clocks are disabled. An interrupt request from a module can cause an exit from stop mode. Stacking for interrupts begins after the selected stop recovery time has elapsed. Reset or break also causes an exit from stop mode.

The SIM disables the oscillator signals (BUSCLKX2 and BUSCLKX4) in stop mode, stopping the CPU and peripherals. Stop recovery time is selectable using the SSREC bit in the configuration register 1 (CONFIG1). If SSREC is set, stop recovery is reduced from the normal delay of 4096 BUSCLKX4 cycles down to 32. This is ideal for the internal oscillator, RC oscillator, and external oscillator options which do not require long start-up times from stop mode.

NOTE

External crystal applications should use the full stop recovery time by clearing the SSREC bit.

Timer Interface Module (TIM)



RST, IRQ: Pins have internal (about 30K Ohms) pull up

PTA[0:5]: High current sink and source capability

PTA[0:5]: Pins have programmable keyboard interrupt and pull up

PTB[0:7]: Not available on 8-pin devices – MC68HC908QT1, MC68HC908QT2, and MC68HC908QT4 (see note in [12.1 Introduction](#))

ADC: Not available on the MC68HC908QY1 and MC68HC908QT1

Figure 14-1. Block Diagram Highlighting TIM Block and Pins

14.4.4.1 Unbuffered PWM Signal Generation

Any output compare channel can generate unbuffered PWM pulses as described in [14.4.4 Pulse Width Modulation \(PWM\)](#). The pulses are unbuffered because changing the pulse width requires writing the new pulse width value over the old value currently in the TIM channel registers.

An unsynchronized write to the TIM channel registers to change a pulse width value could cause incorrect operation for up to two PWM periods. For example, writing a new value before the counter reaches the old value but after the counter reaches the new value prevents any compare during that PWM period. Also, using a TIM overflow interrupt routine to write a new, smaller pulse width value may cause the compare to be missed. The TIM may pass the new value before it is written.

Use the following methods to synchronize unbuffered changes in the PWM pulse width on channel x:

- When changing to a shorter pulse width, enable channel x output compare interrupts and write the new value in the output compare interrupt routine. The output compare interrupt occurs at the end of the current pulse. The interrupt routine has until the end of the PWM period to write the new value.
- When changing to a longer pulse width, enable TIM overflow interrupts and write the new value in the TIM overflow interrupt routine. The TIM overflow interrupt occurs at the end of the current PWM period. Writing a larger value in an output compare interrupt routine (at the end of the current pulse) could cause two output compares to occur in the same PWM period.

NOTE

In PWM signal generation, do not program the PWM channel to toggle on output compare. Toggling on output compare prevents reliable 0% duty cycle generation and removes the ability of the channel to self-correct in the event of software error or noise. Toggling on output compare also can cause incorrect PWM signal generation when changing the PWM pulse width to a new, much larger value.

14.4.4.2 Buffered PWM Signal Generation

Channels 0 and 1 can be linked to form a buffered PWM channel whose output appears on the TCH0 pin. The TIM channel registers of the linked pair alternately control the pulse width of the output.

Setting the MS0B bit in TIM channel 0 status and control register (TSC0) links channel 0 and channel 1. The TIM channel 0 registers initially control the pulse width on the TCH0 pin. Writing to the TIM channel 1 registers enables the TIM channel 1 registers to synchronously control the pulse width at the beginning of the next PWM period. At each subsequent overflow, the TIM channel registers (0 or 1) that control the pulse width are the ones written to last. TSC0 controls and monitors the buffered PWM function, and TIM channel 1 status and control register (TSC1) is unused. While the MS0B bit is set, the channel 1 pin, TCH1, is available as a general-purpose I/O pin.

NOTE

In buffered PWM signal generation, do not write new pulse width values to the currently active channel registers. User software should track the currently active channel to prevent writing a new value to the active channel. Writing to the active channel registers is the same as generating unbuffered PWM signals.

15.2.2.1 Break Status and Control Register

The break status and control register (BRKSCR) contains break module enable and status bits.

Address: \$FE0B

	Bit 7	6	5	4	3	2	1	Bit 0
Read:	BRKE	BRKA	0	0	0	0	0	0
Write:								
Reset:	0	0	0	0	0	0	0	0


 = Unimplemented

Figure 15-3. Break Status and Control Register (BRKSCR)

BRKE — Break Enable Bit

This read/write bit enables breaks on break address register matches. Clear BRKE by writing a 0 to bit 7. Reset clears the BRKE bit.

- 1 = Breaks enabled on 16-bit address match
- 0 = Breaks disabled

BRKA — Break Active Bit

This read/write status and control bit is set when a break address match occurs. Writing a 1 to BRKA generates a break interrupt. Clear BRKA by writing a 0 to it before exiting the break routine. Reset clears the BRKA bit.

- 1 = Break address match
- 0 = No break address match

15.2.2.2 Break Address Registers

The break address registers (BRKH and BRKL) contain the high and low bytes of the desired breakpoint address. Reset clears the break address registers.

Address: \$FE09

	Bit 7	6	5	4	3	2	1	Bit 0
Read:	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8
Write:								
Reset:	0	0	0	0	0	0	0	0

Figure 15-4. Break Address Register High (BRKH)

Address: \$FE0A

	Bit 7	6	5	4	3	2	1	Bit 0
Read:	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
Write:								
Reset:	0	0	0	0	0	0	0	0

Figure 15-5. Break Address Register Low (BRKL)

Table 15-4. WRITE (Write Memory) Command

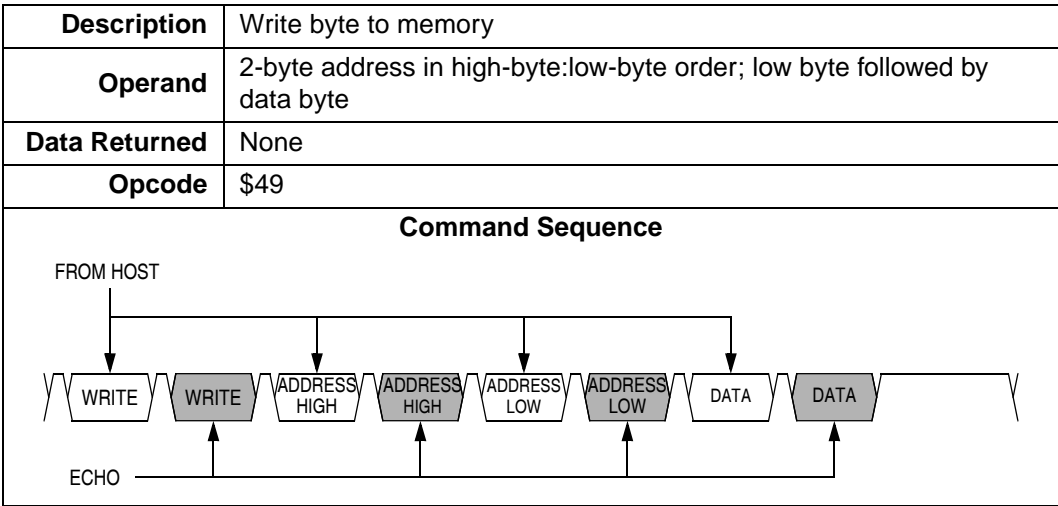


Table 15-5. IREAD (Indexed Read) Command

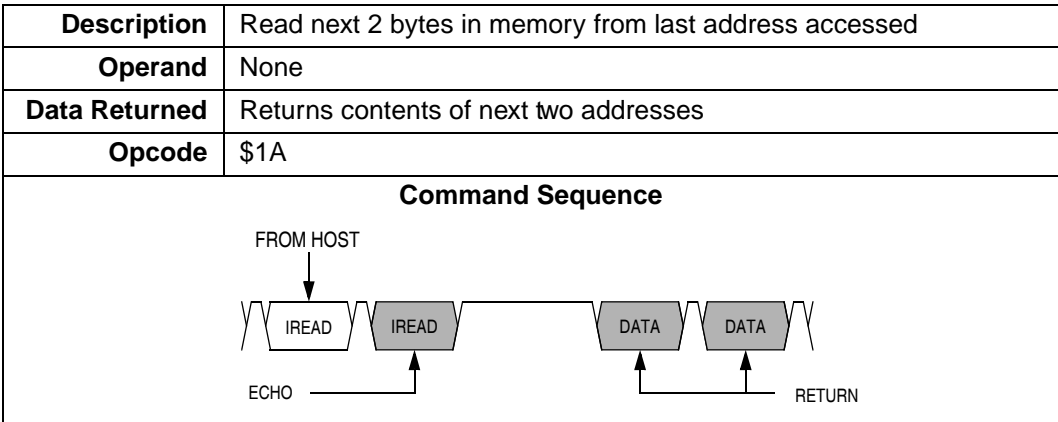
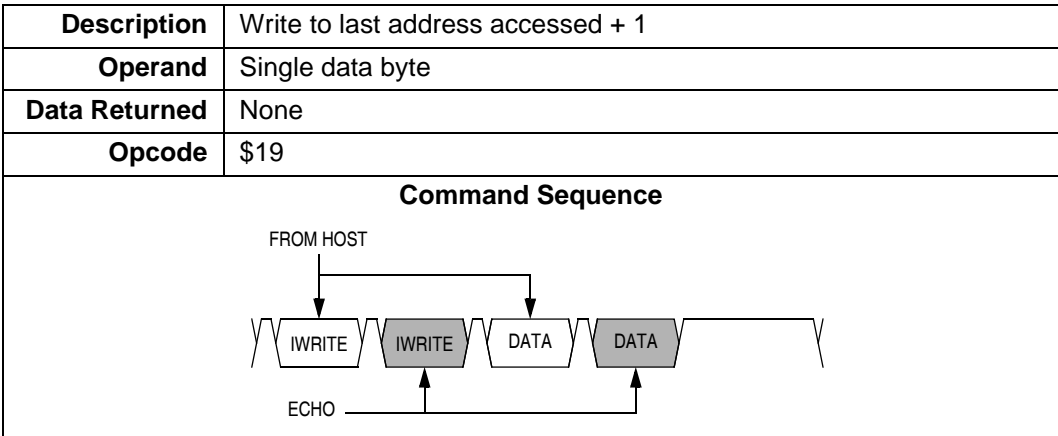


Table 15-6. IWRITE (Indexed Write) Command



A sequence of IREAD or IWRITE commands can access a block of memory sequentially over the full 64-Kbyte memory map.

16.6 Typical 5-V Output Drive Characteristics

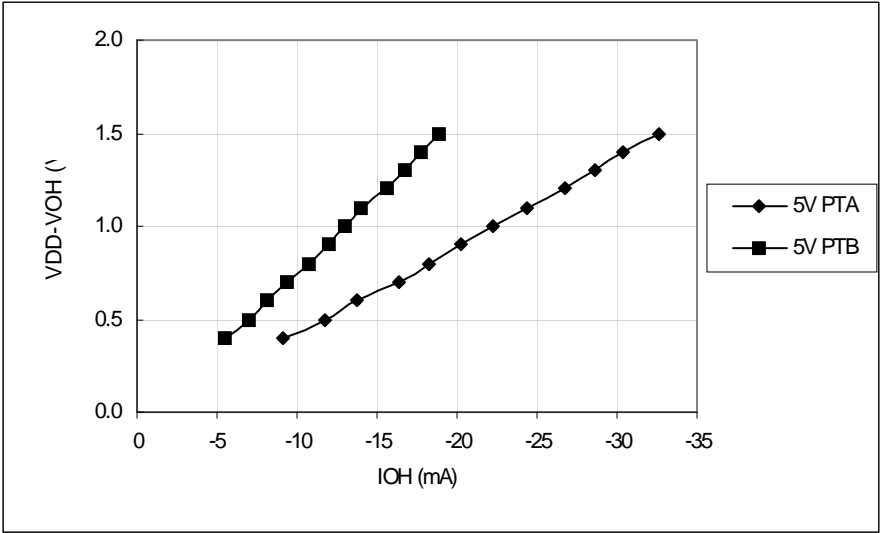


Figure 16-1. Typical 5-Volt Output High Voltage versus Output High Current (25°C)

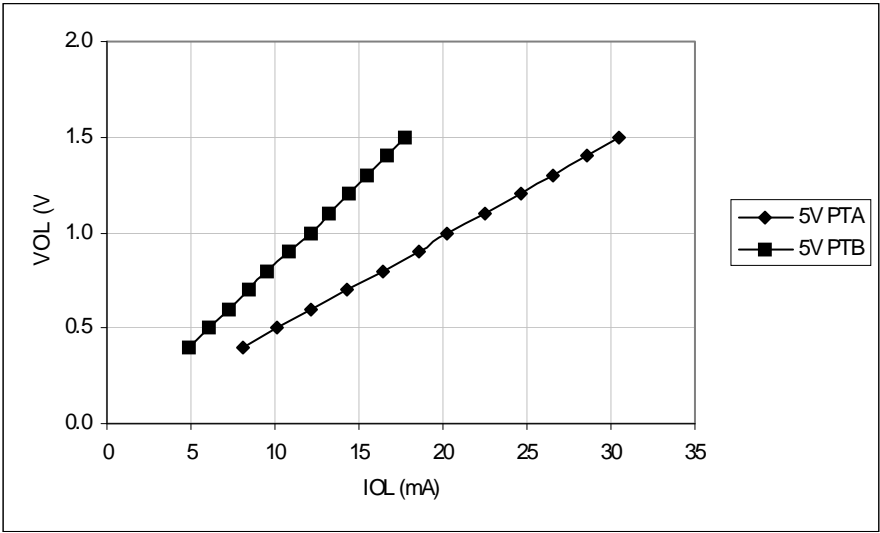


Figure 16-2. Typical 5-Volt Output Low Voltage versus Output Low Current (25°C)

16.9 3-V DC Electrical Characteristics

Characteristic ⁽¹⁾	Symbol	Min	Typ ⁽²⁾	Max	Unit
Output high voltage $I_{Load} = -0.6 \text{ mA}$, all I/O pins $I_{Load} = -4.0 \text{ mA}$, all I/O pins $I_{Load} = -10.0 \text{ mA}$, PTA0, PTA1, PTA3–PTA5 only	V_{OH}	$V_{DD} - 0.3$ $V_{DD} - 1.0$ $V_{DD} - 0.8$	— — —	— — —	V
Maximum combined I_{OH} (all I/O pins)	I_{OHT}	—	—	50	mA
Output low voltage $I_{Load} = 0.5 \text{ mA}$, all I/O pins $I_{Load} = 6.0 \text{ mA}$, all I/O pins $I_{Load} = 10.0 \text{ mA}$, PTA0, PTA1, PTA3–PTA5 only	V_{OL}	— — —	— — —	0.3 1.0 0.8	V
Maximum combined I_{OL} (all I/O pins)	I_{OLT}	—	—	50	mA
Input high voltage PTA0–PTA5, PTB0–PTB7	V_{IH}	$0.7 \times V_{DD}$	—	V_{DD}	V
Input low voltage PTA0–PTA5, PTB0–PTB7	V_{IL}	V_{SS}	—	$0.3 \times V_{DD}$	V
Input hysteresis	V_{HYS}	$0.06 \times V_{DD}$	—	—	V
DC injection current, all ports	I_{INJ}	–2	—	+2	mA
Total dc current injection (sum of all I/O)	I_{INJTOT}	–25	—	+25	mA
Ports Hi-Z leakage current	I_{IL}	–1	± 0.1	+1	μA
Capacitance Ports (as input) Ports (as input)	C_{IN} C_{OUT}	— —	— —	12 8	pF
POR rearm voltage ⁽³⁾	V_{POR}	0	—	100	mV
POR rise time ramp rate ⁽⁴⁾	R_{POR}	0.035	—	—	V/ms
Monitor mode entry voltage	V_{TST}	$V_{DD} + 2.5$	—	$V_{DD} + 4.0$	V
Pullup resistors ⁽⁵⁾ PTA0–PTA5, PTB0–PTB7	R_{PU}	16	26	36	$k\Omega$
Low-voltage inhibit reset, trip falling voltage	V_{TRIPF}	2.40	2.55	2.70	V
Low-voltage inhibit reset, trip rising voltage	V_{TRIPR}	2.50	2.65	2.80	V
Low-voltage inhibit reset/recover hysteresis	V_{HYS}	—	60	—	mV

1. $V_{DD} = 2.7$ to 3.3 Vdc , $V_{SS} = 0 \text{ Vdc}$, $T_A = T_L$ to T_H , unless otherwise noted.

2. Typical values reflect average measurements at midpoint of voltage range, 25°C only.

3. Maximum is highest voltage that POR is guaranteed.

4. If minimum V_{DD} is not reached before the internal POR reset is released, the LVI will hold the part in reset until minimum V_{DD} is reached.

5. R_{PU} are measured at $V_{DD} = 3.0 \text{ V}$



Chapter 17

Ordering Information and Mechanical Specifications

17.1 Introduction

This section contains order numbers for the MC68HC908QY1, MC68HC908QY2, MC68HC908QY4, MC68HC908QT1, MC68HC908QT2, and MC69HC908QT4. Dimensions are given for:

- 8-pin plastic dual in-line package (PDIP)
- 8-pin small outline integrated circuit (SOIC) package
- 8-pin dual flat no lead (DFN) package
- 16-pin PDIP
- 16-pin SOIC
- 16-pin thin shrink small outline package (TSSOP)

17.2 MC Order Numbers

Table 17-1. MC Order Numbers

MC Order Number	ADC	FLASH Memory	Package
MC908QY1	—	1536 bytes	16-pins PDIP, SOIC, and TSSOP
MC908QY2	Yes	1536 bytes	
MC908QY4	Yes	4096 bytes	
MC908QT1	—	1536 bytes	8-pins PDIP, SOIC, and DFN
MC908QT2	Yes	1536 bytes	
MC908QT4	Yes	4096 bytes	

Temperature and package designators:

- C = -40°C to +85°C
- V = -40°C to +105°C
- M = -40°C to +125°C
- P = Plastic dual in-line package (PDIP)
- DW = Small outline integrated circuit package (SOIC)
- DT = Thin shrink small outline package (TSSOP)
- FQ = Dual flat no lead (DFN)

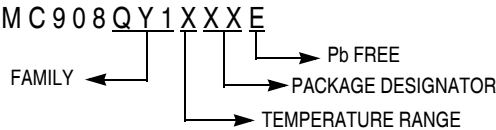
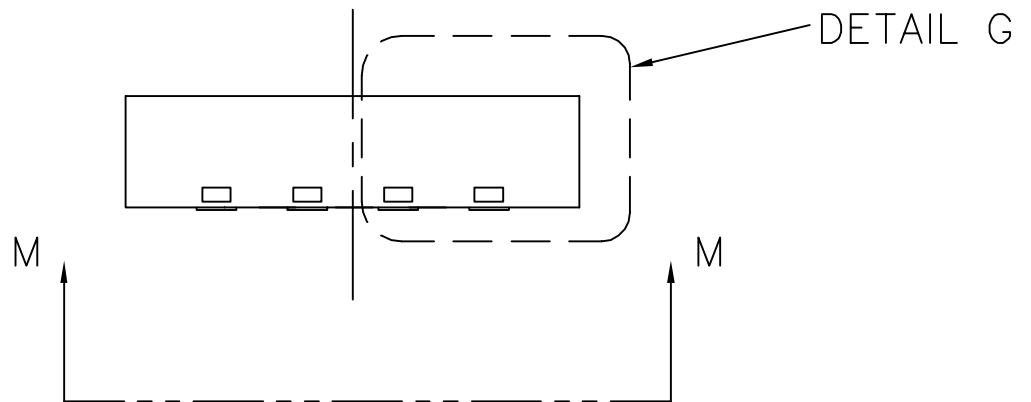
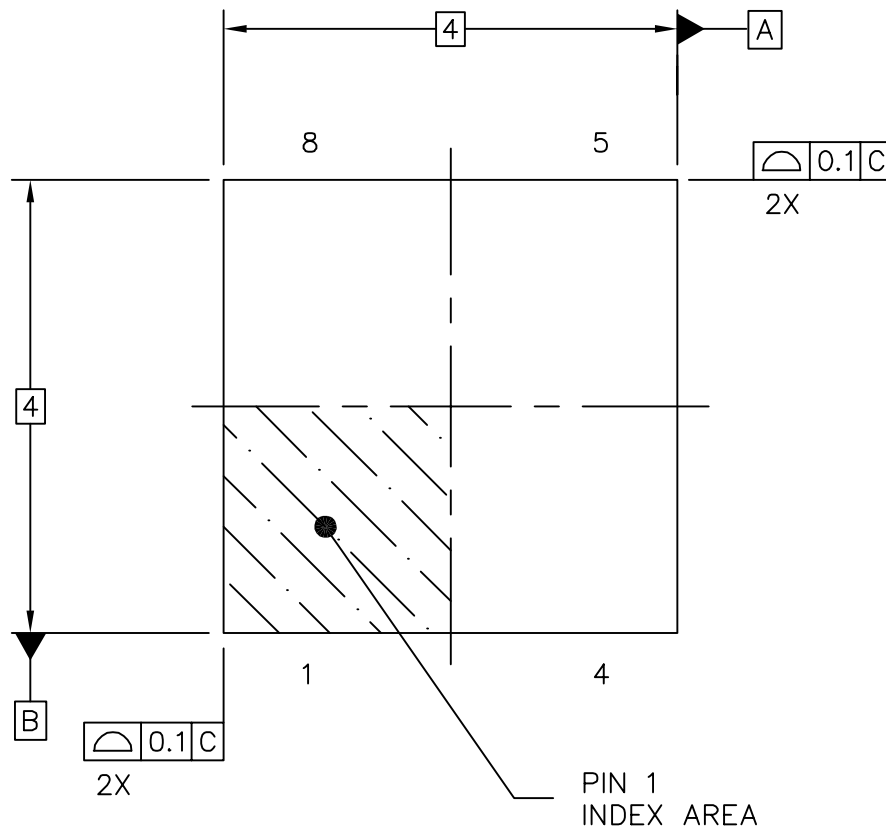


Figure 17-1. Device Numbering System

17.3 Package Dimensions

Refer to the following pages for detailed package dimensions.



TITLE: THERMALLY ENHANCED DUAL
FLAT NO LEAD PACKAGE (DFN)
8 TERMINAL, 0.8 PITCH (4 X 4 X 1)

CASE NUMBER: 1452-01

STANDARD: NON-JEDEC

PACKAGE CODE: 6165

SHEET: 1 OF 5

